

# UNISONIC TECHNOLOGIES CO., LTD

### UT7852

Preliminary

## N-CHANNEL 80V (D-S) MOSFET

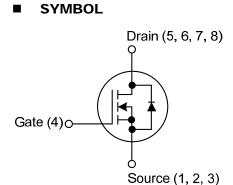
#### DESCRIPTION

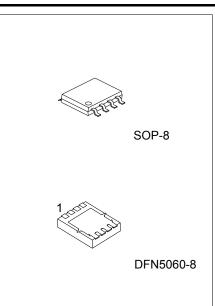
The UTC **UT7852** is an N-Channel MOSFET, it uses UTC's advanced technology to provide customers with a minimum on-state resistance and high switching speed.

The UTC **UT7852** is suitable for primary side switch for DC/DC applications.

#### FEATURES

- \* High switching speed
- \* Low on-state resistance





#### ORDERING INFORMATION

Ordering Number		Daakaga	Pin Assignment						Dooking			
Lead Free	Halogen Free	Package	1	2	З	4	5	6	7	8	Packing	
UT7852L-S08-R	UT7852G-S08-R	SOP-8	S	S	S	G	D	D	D	D	Tape Reel	
UT7852L-K08-5060-R	UT7852G-K08-5060-R	DFN5060-8	S	s	s	G	D	D	D	D	Tape Reel	
Note: Pin Assignment: G: Gate D: Drain S: Source												

UT7852G- <u>S08</u> -R (1)Packing Type	(1) R: Tape Reel
(2)Package Type	(2) S08: UT7852, K08-5060: DFN5060-8
(3)Green Package	(3) G: Halogen Free and Lead Free, L: Lead Free

#### MARKING

SOP-8	DFN5060-8						
8 7 6 5 Date Code   UTC □□□□ L: Lead Free   UT7852 → G: Halogen Free   ● □□→ Lot Code   1 2 3 4	UTC UT 7852 Lot Code ← Date Code						
T C WWW							

www.unisonic.com.tw Copyright © 2015 Unisonic Technologies Co., Ltd 3

#### ■ ABSOLUTE MAXIMUM RATINGS (T<sub>A</sub>=25°C, unless otherwise noted)

PARAMETER			SYMBOL	RATINGS	UNIT
Drain-Source Voltage			V <sub>DSS</sub>	80	V
Gate-Source Voltage			$V_{GSS}$	±20	V
Pulsed Drain Current			I <sub>DM</sub>	50	А
Continuous Drain Current T <sub>A</sub> =25°C		- I <sub>D</sub> -	12.5	А	
(T <sub>J</sub> =150°C )(Note 1) T <sub>A</sub> =70°C			10.0	А	
Avalanche Current L=0.1mH		I <sub>AS</sub>	40	А	
Continuous Source Current (Diode Conduction) (Note 1)		Is	4.7	Α	
Power Dissipation	T <sub>A</sub> =25°C	SOP-8	<b>D</b>	1.5	W
(Note 1)	T <sub>A</sub> -25 C	DFN5060-8	PD	5.2	W
Junction Temperature		ТJ	-55 ~ +150	°C	
Storage Temperature Range			T <sub>STG</sub>	-55 ~ +150	°C
Soldering Recommendations (Peak Temperature)				260	°C

Note: Absolute maximum ratings are those values beyond which the device could be permanently damaged. Absolute maximum ratings are stress ratings only and functional device operation is not implied.

#### THERMAL CHARACTERISTICS

PARAMETER	SYMBOL	MIN	TYP	MAX	UNIT	
Junction to Ambient (Note 1)	SOP-8	0			85	°C/W
	DFN5060-8	θ <sub>JA</sub>		52	65	°C/W
Junction to Case (Drain)	SOP-8	0			24	°C/W
	DFN5060-8	θις		1.5	1.8	°C/W

Note: Surface Mounted on 1" x 1" FR4 board.

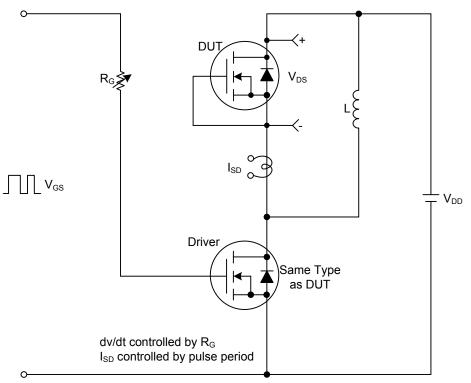
#### ■ ELECTRICAL CHARACTERISTICS (TJ=25°C, unless otherwise noted)

PARAMETER		SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
OFF CHARACTERISTICS							
Zero Gate Voltage Drain Current			V <sub>DS</sub> =80V, V <sub>GS</sub> =0V			1	μA
		I <sub>DSS</sub>	V <sub>DS</sub> =80V, V <sub>GS</sub> =0V, T <sub>J</sub> =55°C			5	μA
Gate-Source Leakage Current	Forward		V <sub>GS</sub> =+20V, V <sub>DS</sub> =0V			+100	nA
	Reverse	I <sub>GSS</sub>	V <sub>GS</sub> =-20V, V <sub>DS</sub> =0V			-100	nA
ON CHARACTERISTICS							
Gate Threshold Voltage		V <sub>GS(TH)</sub>	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =250µA	2.0			V
Static Drain-Source On-State Re	esistance		V <sub>GS</sub> =10V, I <sub>D</sub> =10A		12.5	16.5	mΩ
(Note 1)		R <sub>DS(ON)</sub>	V <sub>GS</sub> =6.0V, I <sub>D</sub> =8.0A		14	22	mΩ
Forward Transconductance (Note 1)		<b>g</b> fs	V <sub>DS</sub> =15V, I <sub>D</sub> =10A		25		S
On State Drain Current (Note 1)		I <sub>D(ON)</sub>	V <sub>DS</sub> ≥5V, V <sub>GS</sub> =10V	50			А
DYNAMIC PARAMETERS (Not	te 2)						
Gate Resistance		R <sub>G</sub>			2		Ω
SWITCHING PARAMETERS							
Total Gate Charge		$Q_{G}$			34	41	nC
Gate to Source Charge		Q <sub>GS</sub>	V <sub>GS</sub> =10V, V <sub>DS</sub> =40V, I <sub>D</sub> =10A		7.5		nC
Gate to Drain Charge		Q <sub>GD</sub>			11.0		nC
Turn-ON Delay Time		t <sub>D(ON)</sub>			120		ns
Rise Time		t <sub>R</sub>	V <sub>DD</sub> =30V, R <sub>L</sub> =60Ω, I <sub>D</sub> ≈0.5A,	0	130		ns
Turn-OFF Delay Time		t <sub>D(OFF)</sub>	$V_{GEN}$ =10V, $R_{G}$ =25 $\Omega$	11.	700		ns
Fall-Time		t⊨	14 .08.		220		ns
SOURCE- DRAIN DIODE RATI	NGS AND	CHARACTER	RISTICS VX 100				
Diode Forward Voltage (Note 1)		V <sub>SD</sub>	Is=2.8A, V <sub>GS</sub> =0V		0.75	1.1	V
Source-Drain Reverse Recovery Time		trr	l <sub>F</sub> =2.8A, dl/dt=100A/μs		45	75	ns

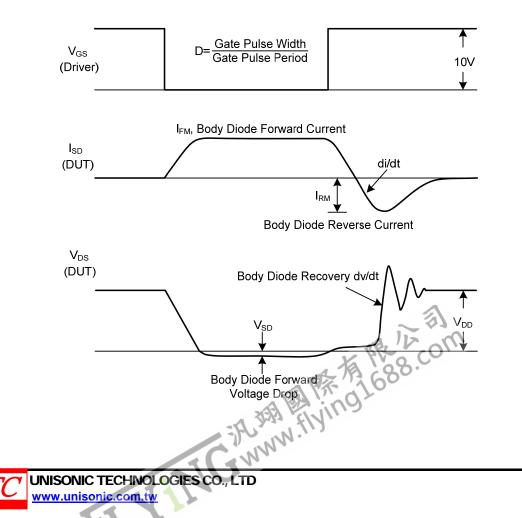
Notes: 1. Pulse test: pulse width  $\leq$  300µs, duty cycle  $\leq$  2%.

2. Guaranteed by design, not subject to production testing.

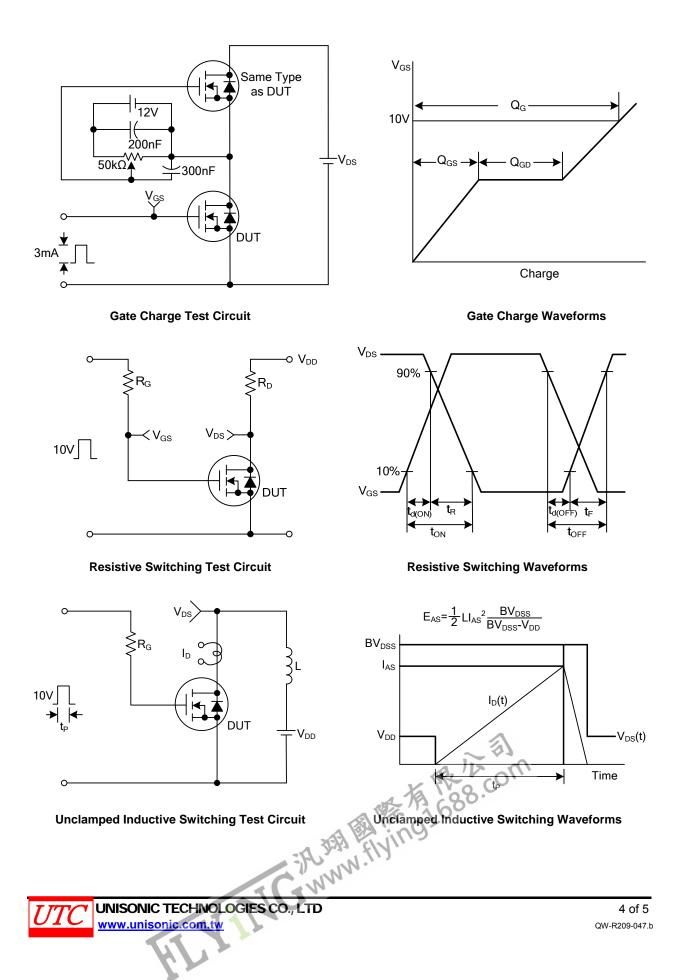
#### ■ TEST CIRCUITS AND WAVEFORMS



#### Peak Diode Recovery dv/dt Test Circuit & Waveforms



#### TEST CIRCUITS AND WAVEFORMS



UTC assumes no responsibility for equipment failures that result from using products at values that exceed, even momentarily, rated values (such as maximum ratings, operating condition ranges, or other parameters) listed in products specifications of any and all UTC products described or contained herein. UTC products are not designed for use in life support appliances, devices or systems where malfunction of these products can be reasonably expected to result in personal injury. Reproduction in whole or in part is prohibited without the prior written consent of the copyright owner. UTC reserves the right to make changes to information published in this document, including without limitation specifications and product descriptions, at any time and without notice. This document supersedes and replaces all information supplied prior to the publication hereof.

